



**SEMI F47 Compliance Certificate**  
**PULS Power Supply**  
**EPRI Solutions Inc. PQ Star Test Program**  
**Certification Date: 4/22/05**

**PQ Star Reference Number:**  
SEMIF47.105

**Manufacturer:** PULS

**Product:** Dimension 24Vdc Power Supply

**Model Number:** QS5.DNET

**Serial Number (Unit Tested):** 2433680

*See Attachment A for Detailed Test Results*

*See Attachment C for SEMI F47 Description*

**Test Configuration:** The *Power Supply* was tested using SEMI F42 compliant voltage sag generator equipment. See Attachment B for details.

**Test Date:** 4/22/05

**Test Location:**  
EPRI Solutions Inc.  
942 Corridor Park Blvd  
Knoxville, TN 37932

**Electrical Environment:**  
120/208Vac Single Phase, 50/60 Hz  
(See Attachment A for details.)

This letter and subsequent documentation certifies that the Puls Dimension QS5.DNET power supply detailed in this document, in its original configuration has been voltage sag tested per **SEMI F42** test protocol and was found to comply with the **SEMI F47** voltage sag immunity standard at 100% load, at 50/60Hz at 120/208Vac. This certification remains valid to the models tested only and as long as no component substitutions are made. Compliance will be subject to reevaluation three-years from date of this certification.

Certified by,

**Dennis Turner**  
PQ Star Certification Specialist  
EPRI Solutions, Incorporated



**PULS QS5.DNET Power Supply**



## Attachment A – SEMI F47 Test Results

Testing was performed ESI's Power Quality Laboratory in Knoxville, TN. The test protocol followed was SEMI F42 Test Method for Semiconductor Processing Equipment Voltage Sag Immunity. To ensure maximum accuracy of the test, a variable voltage source was used to set the voltage to exactly 120/208Vac. This was verified at the power supply with a qualified meter. During the voltage sag test, the power supply was connected to a variable resistive load bank and loaded to 100% of its load. Table A-1 shows the power supplies rated full load conditions, and the actual load it was tested at.

Table A-2 lists all points tested per SEMI F42 test method, and Figure A-1 shows the power supplies specific SEMI F47 ride-through curve at 120Vac, and Figure A-2 shows the power supplies specific SEMI F47 ride-through curve at 208Vac. The specific SEMI F47 test points are highlighted for both 50 and 60 Hz. The power supply was tested at points below the curve to fully characterize the components. During the testing of SEMI F47 test points (1s at 80%, 0.5s at 70%, 0.2s at 50%, and 0.05s at 50%) the output voltage of the power supply did not deviate. The power supply passed at 50 and 60 Hz, loaded to 100% of resistive load.

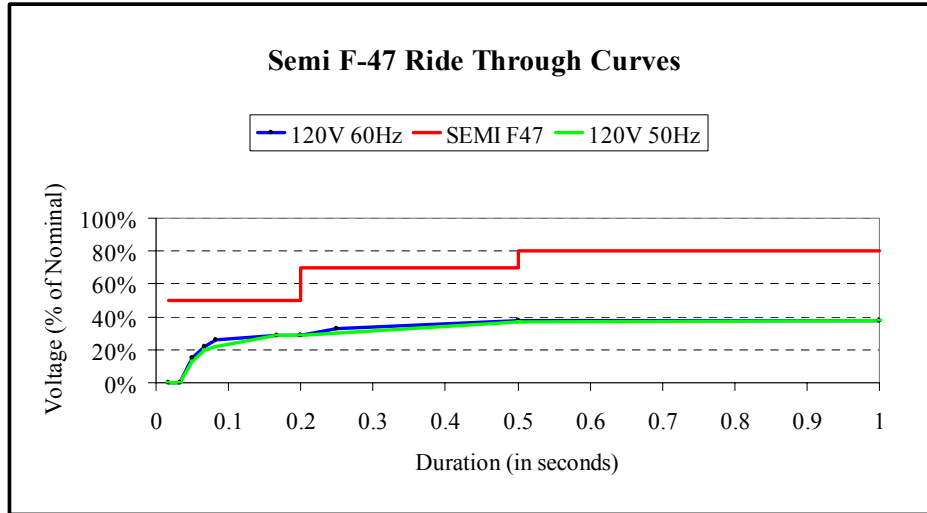
**Table A-1 Power Supplies Ratings**

Evaluated at 120/208Vac							
Manufacture	Power Supply	Vdc	I	R	W	Actual load	Result
PULS	QS5.DNET	24	3.8	6.26	92	100%	Passed

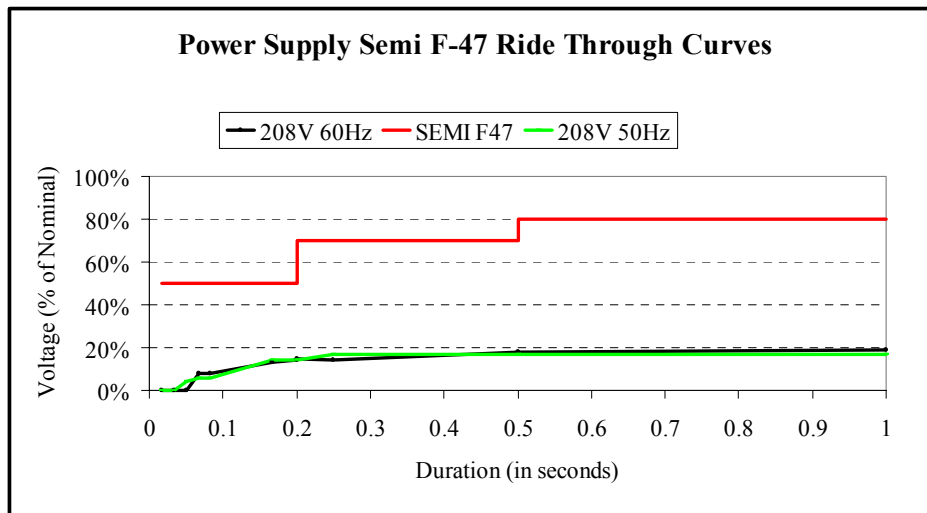
**Table A-2. PULS  
QS5.DNET Test Results**

Duration			Percent of Nominal					Results
Seconds	60Hz Cycles	50Hz Cycles	120Vac 60Hz	120Vac 50Hz	208Vac 60Hz	208Vac 50Hz	SEMI F47	
1	60	50	38%	38%	19%	17%	80%	Passed
0.5	30	25	38%	37%	18%	17%	80%	Passed
0.5	30	25	38%	37%	18%	17%	70%	Passed
0.25	15	12.5	33%	30%	14%	17%	70%	Passed
0.2	12	10	29%	29%	15%	14%	70%	Passed
0.2	12	10	29%	29%	14%	14%	50%	Passed
0.17	10	8.5	29%	29%	13%	14%	50%	Passed
0.08	5	4	26%	22%	8%	6%	50%	Passed
0.07	4	3.5	22%	20%	8%	6%	50%	Passed
0.05	3	2.5	15%	13%	0%	4%	50%	Passed
0.03	2	1.5	0%	0%	0%	0%	50%	Passed
0.02	1	1	0%	0%	0%	0%	50%	Passed

**Figure A-1. PULS QS5.DNET SEMI F47 Ride-Through Curve at 120Vac**



**Figure A-2. PULS QS5.DNET SEMI F47 Ride-Through Curve at 208Vac**



## Electrical Environment

Steady state measurements were taken prior to testing. Table A-3 lists measurements taken to characterize the electrical environment of the power supply during SEMI F47 compliance testing, at 50/60 Hz.

**Table A-3. Steady State Measurements for PULS QS5.DNET**

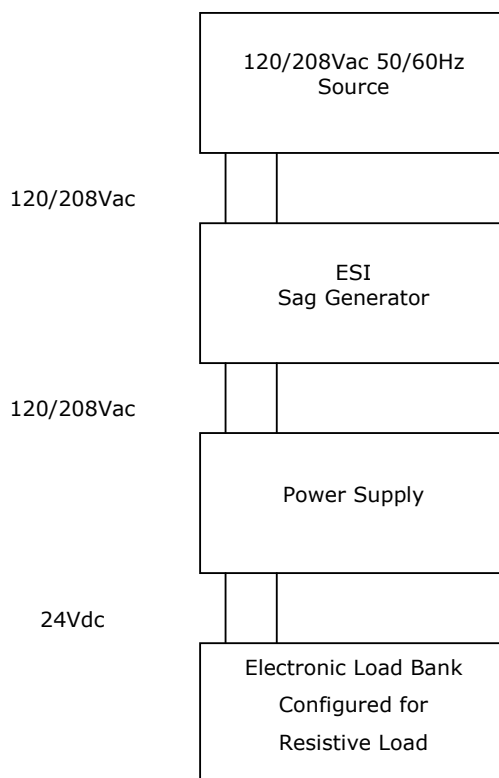
Measurement Parameters	Test Process State 120V/60Hz	Test Process State 120V/50 Hz	Test Process State 208V/60Hz	Test Process State 208V/50Hz
<b>Rated Voltage P-P</b>	100-240	100-240	100-240	100-240
<b>Voltage (V)</b>	120.9	121	209	209
<b>Current (Ia)</b>	0.834	0.83	0.544	0.544
<b>Power (Wa-n)</b>	100	100	103	103
<b>Volt Amps (VA)</b>	101	101	114	114
<b>Vthd (Phase A) %</b>	3.2	3.7	3.2	3.2
<b>Ithd (Phase A) %</b>	10.6	12.8	30.5	30.5
<b>I1</b>	0.828	0.827	0.516	0.516
<b>I3</b>	0.089	0.089	0.154	0.154
<b>I5</b>	0.042	0.037	0.035	0.035
<b>Power Factor</b>	0.99	0.99	0.91	0.91
<b>Crest Factors</b>	1.51	1.51	1.7	1.7
<b>Hertz</b>	60	50	60	50

## Attachment B - Test Configuration

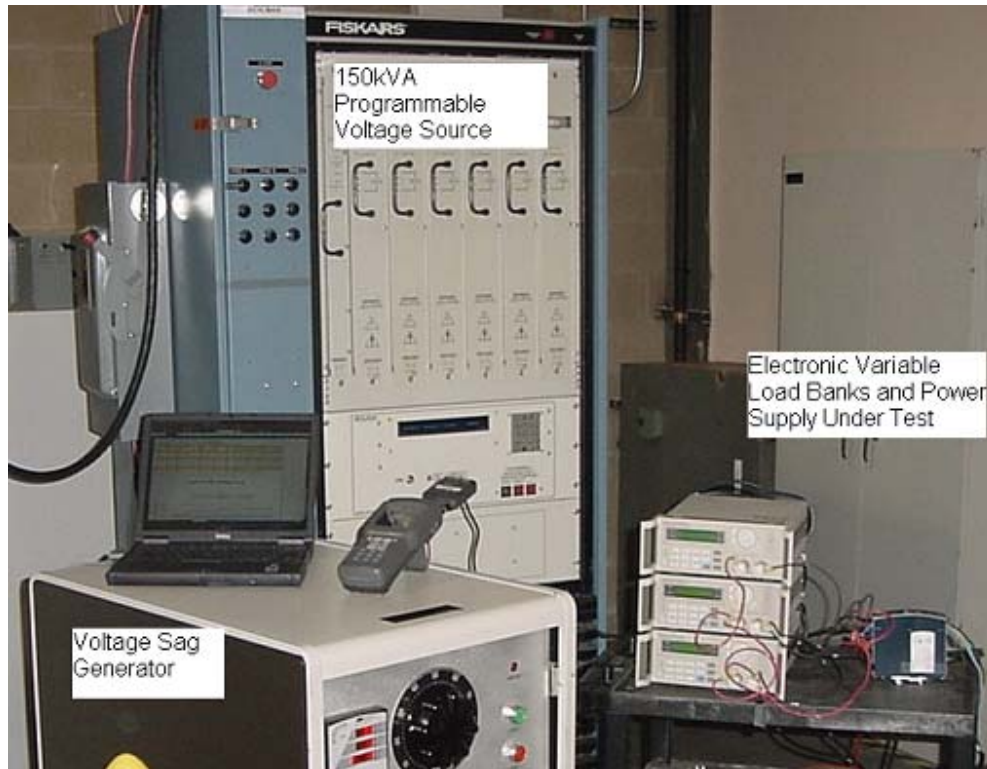
### Test Configuration

The SEMI F42 compliant voltage sag generator was placed in series with the main power feed, in according with SEMI F42 and shown in Figure B-1. The Main power feed for this test was an amplifier that was adjustable for voltage and frequency. This allowed a precise setting of 120/208Vac and 50/60 Hz. A photo of the setup is shown in Figure B-2.

**Figure B-1 – Test Configuration and Setup**



**Figure B-2 - Photo of Test Setup**



## Attachment C - SEMI F47 Abstract

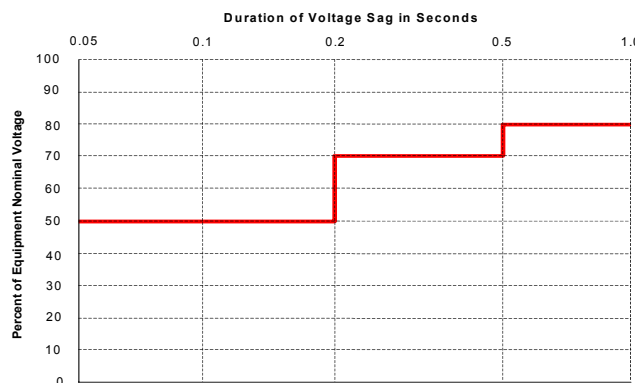
The SEMI F47 “Specification for Semiconductor Processing Equipment Voltage Sag Immunity” document defines the threshold that a semiconductor tool must operate without interruption (per SEMI F42) and it also provides a target for the facility and utility systems. The Recognizing semiconductor factories require high levels of power quality due to the sensitivity of equipment and process controls and that Semiconductor processing equipment is especially vulnerable to voltage sags, this document defines the voltage sag ride-through capability required for semiconductor processing, metrology, and automated test equipment.

The requirements in this international standard were developed to satisfy semiconductor industry needs. While more stringent than existing generic standards, this industry-specific specification is not in conflict with known generic equipment regulations from other regions or generic equipment standards from other organizations. It is the intent of this standard to provide specifications for semiconductor processing equipment that will lead to improved selection criteria for sub-components and improvements in equipment systems design. While it is recognized that in certain extreme cases or for specific functions battery storage devices may be appropriate, it is not the intent of this standard to increase the size or use of battery storage devices provided with equipment. Focus on improvements in equipment component and system design should lead to a reduction or elimination in the use of battery storage devices to achieve equipment reliability during voltage sag events.

The SEMI F47 document specifies the minimum voltage sag ride-through capability design requirements for equipment used in the semiconductor industry. The expected equipment performance capability is shown graphically on a chart representing voltage sag duration and percent deviation of equipment nominal voltage. The primary focus for this specification is semiconductor processing equipment including but not limited to the following tool types:

- Etch equipment (Dry & Wet)
- Film deposition equipment (CVD & PVD)
- Thermal equipment
- Surface prep and clean
- Photolithography equipment (Stepper & Tracks)
- Chemical Mechanical Polishing equipment
- Ion Implant equipment
- Metrology equipment
- Automated test equipment

The actual SEMI F47 ride-through curve is shown below.



**Figure C-1 The SEMI F47 Voltage Sag Ride-Through Curve**

The specification states that Semiconductor processing, metrology, and automated test equipment must be designed and built to conform to the voltage sag ride-through capability per the defined curve. Equipment must continue to operate without interrupt (per SEMI E10 ) during conditions identified in the area above the defined line. In the context of SEMI F47, interrupt means any assist or failure. An assist is defined as an unplanned interruption that occurs during an equipment cycle where all three of the following conditions apply:

- The interrupted equipment cycle is resumed through external intervention (e.g., by an operator or user, either human or host computer).
- There is no replacement of a part, other than specified consumables.
- There is no further variation from specification of equipment operation.

Furthermore, a failure is any unplanned interruption or variance from the specifications of equipment operation other than assists. Although no variation in the tool's process is the goal, this standard addresses these issues as related to the equipment operation only.





### **EPRI Solutions Inc. PQ Star Certification for the Semiconductor Industry**

Having conducted power quality tests on hundreds of devices and electrical equipment since 1992, EPRI Solutions is known worldwide for power quality testing expertise. Since April 1997, EPRI Solutions has conducted voltage sag testing on semiconductor processing tools. In order to serve the semiconductor industry, EPRI Solutions Inc. has established a certification program to test manufacturer equipment per established power quality standards. PQ Star certification for the SEMI F47 standard (Specification for semiconductor Processing Equipment Voltage Sag Immunity) is now available for semiconductor equipment suppliers. EPRI Solutions utilizes the SEMI F42 test standard (Test Method for Semiconductor Processing Equipment Voltage Sag Immunity). With the PQ Star certification, EPRI Solutions Inc. offers a third party verification that the equipment tested meets this important new power quality standard.

For more information about the PQ Star test program for the semiconductor industry or inquire about testing, contact Mark Stephens at [mstephens@epri-solutions.com](mailto:mstephens@epri-solutions.com)

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